

# 2SK3600-01L,S,SJ

## FUJI POWER MOSFET Super FAP-G Series

### N-CHANNEL SILICON POWER MOSFET

#### ■ Features

High speed switching  
Low on-resistance  
No secondary breakdown  
Low driving power  
Avalanche-proof

#### ■ Applications

Switching regulators  
UPS (Uninterruptible Power Supply)  
DC-DC converters

#### ■ Maximum ratings and characteristic Absolute maximum ratings

● (Tc=25°C unless otherwise specified)

| Item                                    | Symbol                  | Ratings              | Unit  |
|-----------------------------------------|-------------------------|----------------------|-------|
| Drain-source voltage                    | V <sub>DS</sub>         | 100                  | V     |
|                                         | V <sub>DSX</sub> *5     | 70                   | V     |
| Continuous drain current                | I <sub>D</sub>          | ±29                  | A     |
| Pulsed drain current                    | I <sub>D</sub> (puls)   | ±116                 | A     |
| Gate-source voltage                     | V <sub>GS</sub>         | ±30                  | V     |
| Non-repetitive Avalanche current        | I <sub>AS</sub> *2      | 29                   | A     |
| Maximum Avalanche Energy                | E <sub>AS</sub> *1      | 155.8                | mJ    |
| Maximum Drain-Source dV/dt              | dV <sub>DS</sub> /dt *4 | 20                   | kV/μs |
| Peak Diode Recovery dV/dt               | dV/dt *3                | 5                    | kV/μs |
| Max. power dissipation                  | P <sub>D</sub>          | T <sub>a</sub> =25°C | 1.67  |
|                                         |                         | T <sub>c</sub> =25°C | 105   |
| Operating and storage temperature range | T <sub>ch</sub>         | +150                 | °C    |
|                                         | T <sub>stg</sub>        | -55 to +150          | °C    |

\*1 L=222μH, V<sub>CC</sub>=48V, T<sub>ch</sub>=25°C, See to Avalanche Energy Graph \*2 T<sub>ch</sub> ≤ 150°C

\*3 I<sub>F</sub> ≤ -I<sub>D</sub>, -di/dt=50A/μs, V<sub>CC</sub> ≤ BV<sub>DSS</sub>, T<sub>ch</sub> ≤ 150°C \*4 V<sub>DS</sub> ≤ 100V \*5 V<sub>GS</sub>=-30V

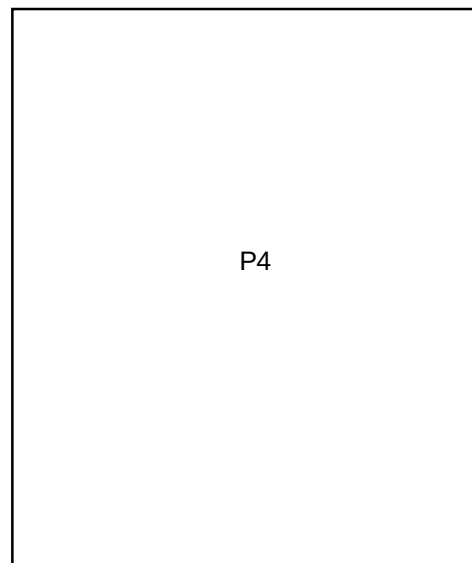
#### ● Electrical characteristics (T<sub>c</sub> =25°C unless otherwise specified)

| Item                             | Symbol               | Test Conditions                                               | Min. | Typ. | Max. | Units |
|----------------------------------|----------------------|---------------------------------------------------------------|------|------|------|-------|
| Drain-source breakdown voltage   | V <sub>(BR)DSS</sub> | I <sub>D</sub> = 250μA V <sub>GS</sub> =0V                    | 100  |      |      | V     |
| Gate threshold voltage           | V <sub>GS(th)</sub>  | I <sub>D</sub> = 250μA V <sub>DS</sub> =V <sub>GS</sub>       | 3.0  |      | 5.0  | V     |
| Zero gate voltage drain current  | I <sub>DSS</sub>     | V <sub>DS</sub> =100V V <sub>GS</sub> =0V                     |      |      | 25   | μA    |
|                                  |                      | V <sub>DS</sub> =80V V <sub>GS</sub> =0V                      |      |      | 250  | μA    |
| Gate-source leakage current      | I <sub>GSS</sub>     | V <sub>GS</sub> =±30V V <sub>DS</sub> =0V                     |      | 10   | 100  | nA    |
| Drain-source on-state resistance | R <sub>DS(on)</sub>  | I <sub>D</sub> =10A V <sub>GS</sub> =10V                      |      | 47   | 62   | mΩ    |
| Forward transconductance         | g <sub>fs</sub>      | I <sub>D</sub> =10A V <sub>DS</sub> =25V                      | 6    | 12   |      | S     |
| Input capacitance                | C <sub>iss</sub>     | V <sub>DS</sub> =75V                                          |      | 730  | 1095 | pF    |
| Output capacitance               | C <sub>oss</sub>     | V <sub>GS</sub> =0V                                           |      | 190  | 285  | pF    |
| Reverse transfer capacitance     | C <sub>rss</sub>     | f=1MHz                                                        |      | 12   | 18   | pF    |
| Turn-on time t <sub>on</sub>     | td(on)               | V <sub>CC</sub> =48V I <sub>D</sub> =10A                      |      | 12   | 18   | ns    |
|                                  | t <sub>r</sub>       | V <sub>GS</sub> =10V                                          |      | 3.8  | 6    | ns    |
| Turn-off time t <sub>off</sub>   | td(off)              | R <sub>GS</sub> =10 Ω                                         |      | 23   | 35   | ns    |
|                                  | t <sub>f</sub>       |                                                               |      | 8.5  | 13   | ns    |
| Total Gate Charge                | Q <sub>G</sub>       | V <sub>CC</sub> =50V                                          |      | 22   | 33   | nC    |
| Gate-Source Charge               | Q <sub>GS</sub>      | I <sub>D</sub> =20A                                           |      | 9    | 13.5 | nC    |
| Gate-Drain Charge                | Q <sub>GD</sub>      | V <sub>GS</sub> =10V                                          |      | 6    | 9    | nC    |
| Avalanche capability             | I <sub>AV</sub>      | L=222μH T <sub>ch</sub> =25°C                                 | 29   |      |      | A     |
| Diode forward on-voltage         | V <sub>SD</sub>      | I <sub>F</sub> =20A V <sub>GS</sub> =0V T <sub>ch</sub> =25°C |      | 1.10 | 1.65 | V     |
| Reverse recovery time            | t <sub>rr</sub>      | I <sub>F</sub> =20A V <sub>GS</sub> =0V                       |      | 65   |      | ns    |
| Reverse recovery charge          | Q <sub>rr</sub>      | -di/dt=100A/μs T <sub>ch</sub> =25°C                          |      | 0.17 |      | μC    |

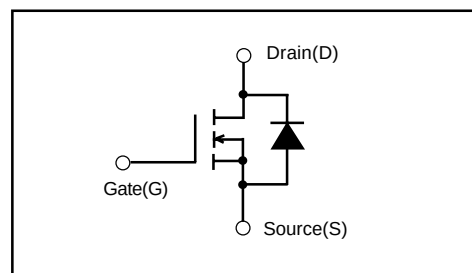
#### ● Thermal characteristics

| Item               | Symbol                | Test Conditions    | Min. | Typ. | Max.  | Units |
|--------------------|-----------------------|--------------------|------|------|-------|-------|
| Thermal resistance | R <sub>th(ch-c)</sub> | channel to case    |      |      | 1.191 | °C/W  |
|                    | R <sub>th(ch-a)</sub> | channel to ambient |      |      | 75.0  | °C/W  |

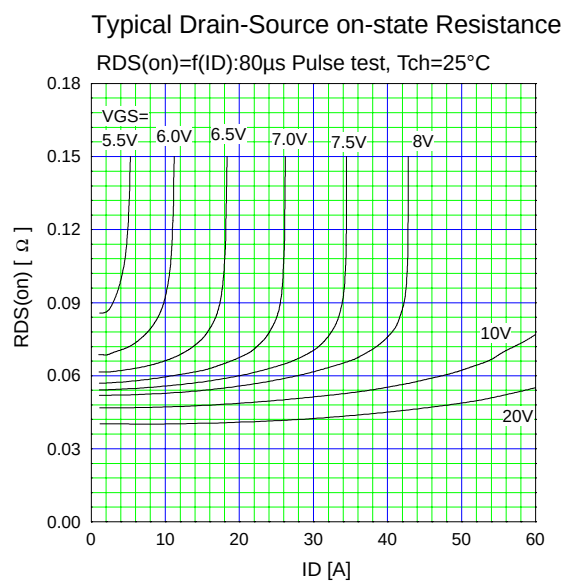
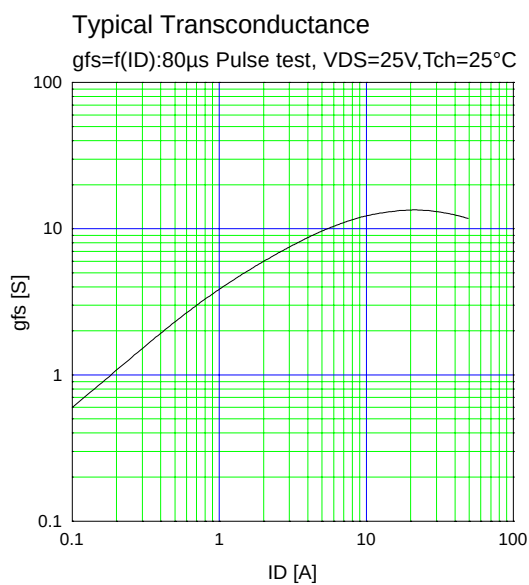
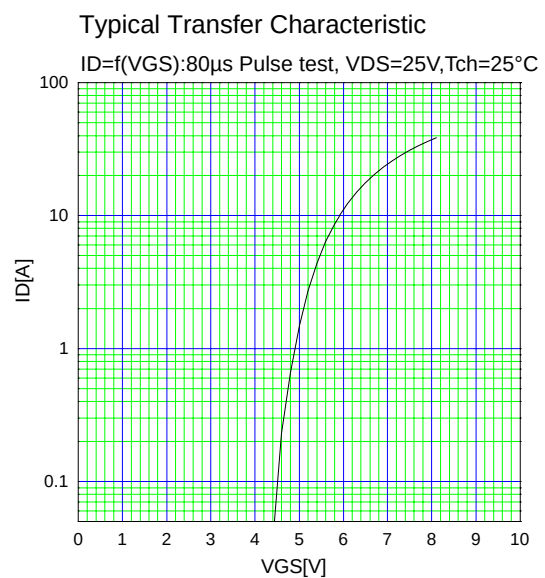
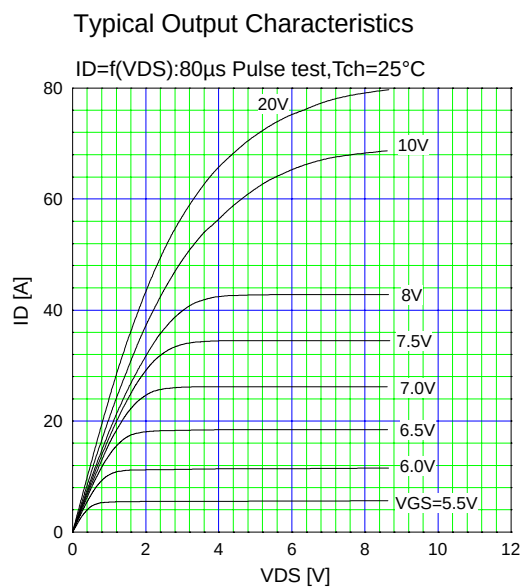
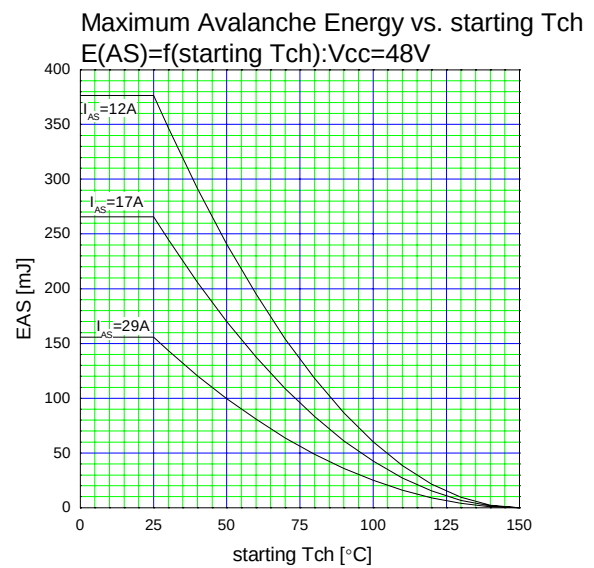
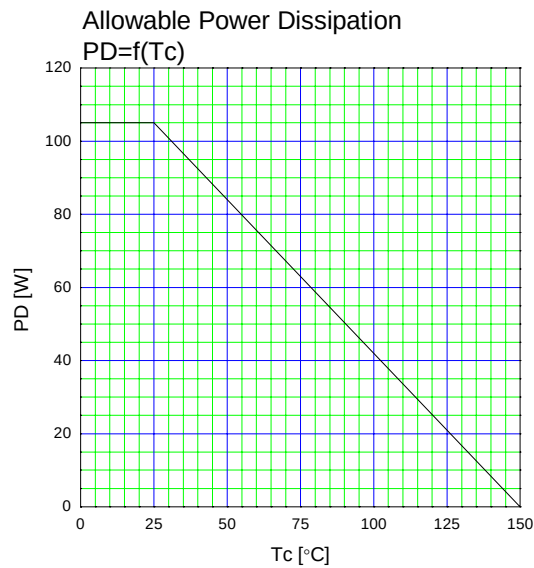
#### ■ Outline Drawings (mm)

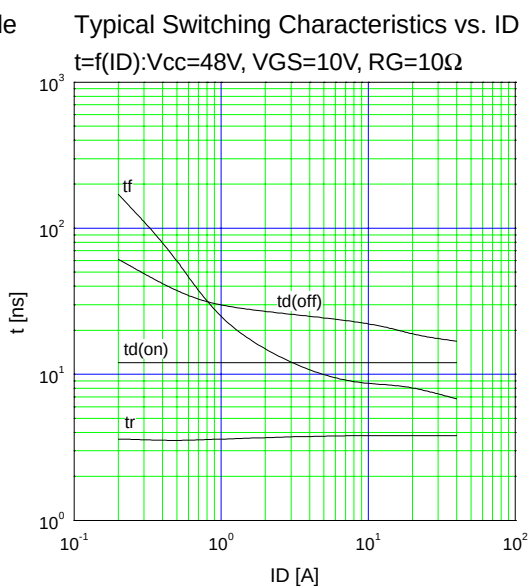
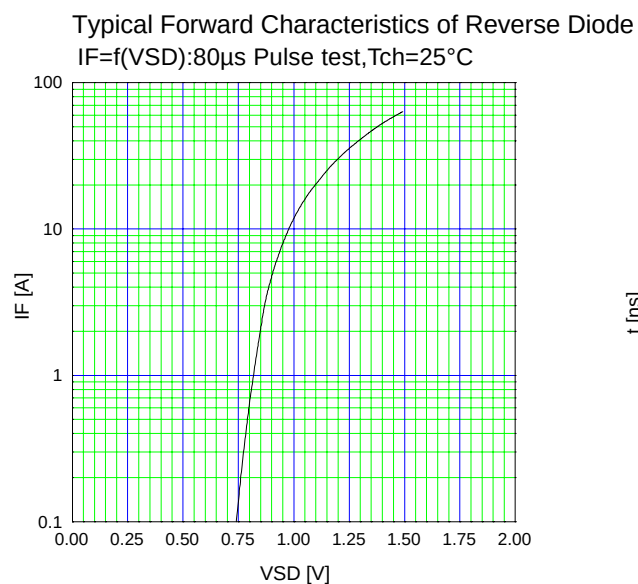
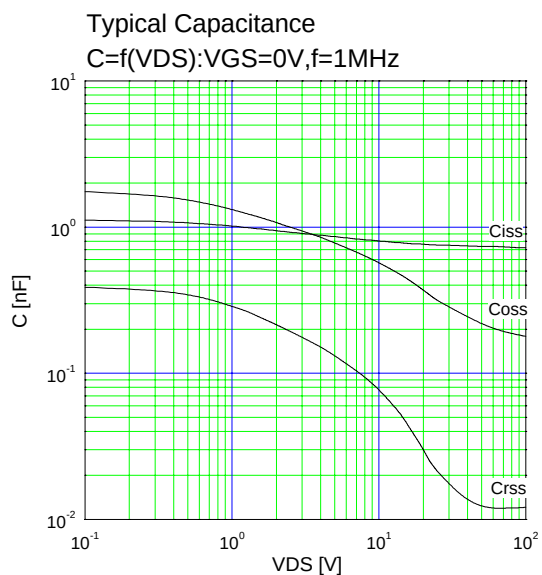
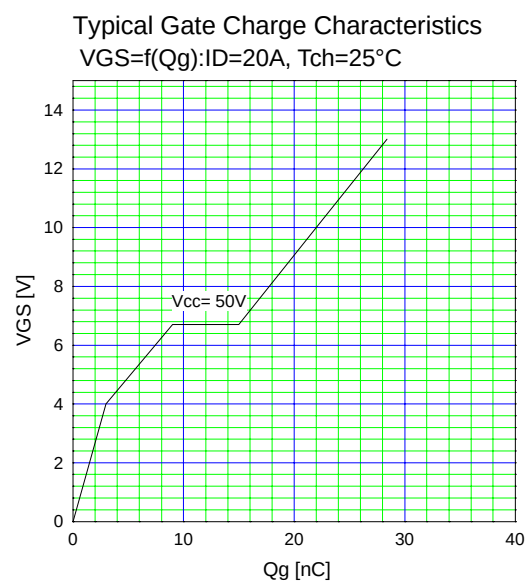
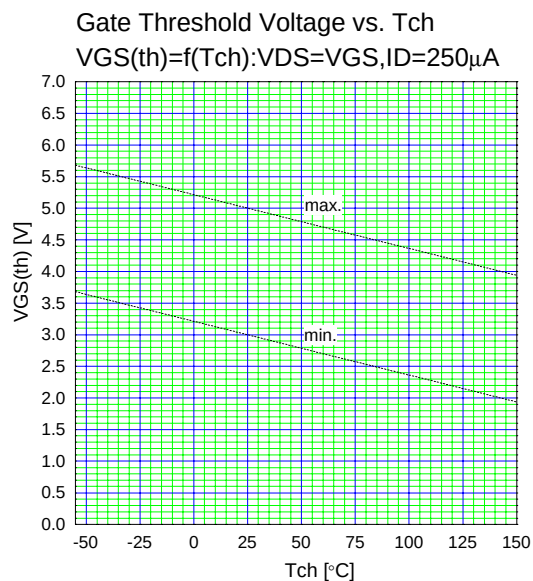
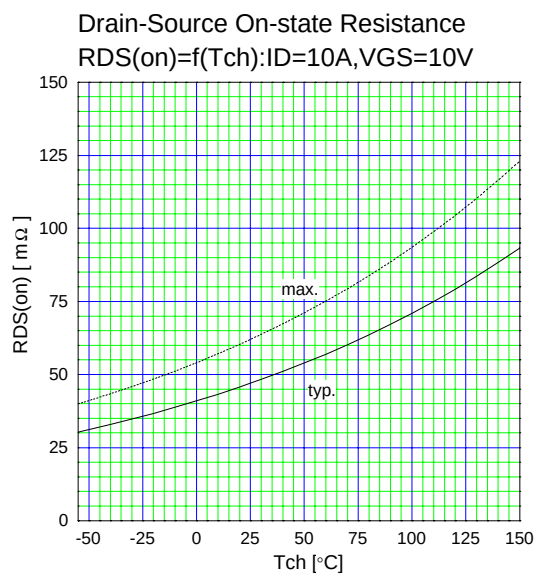


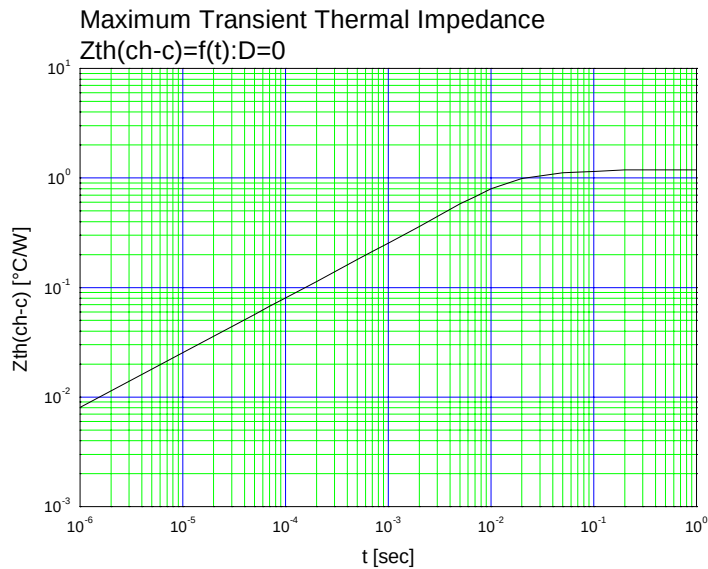
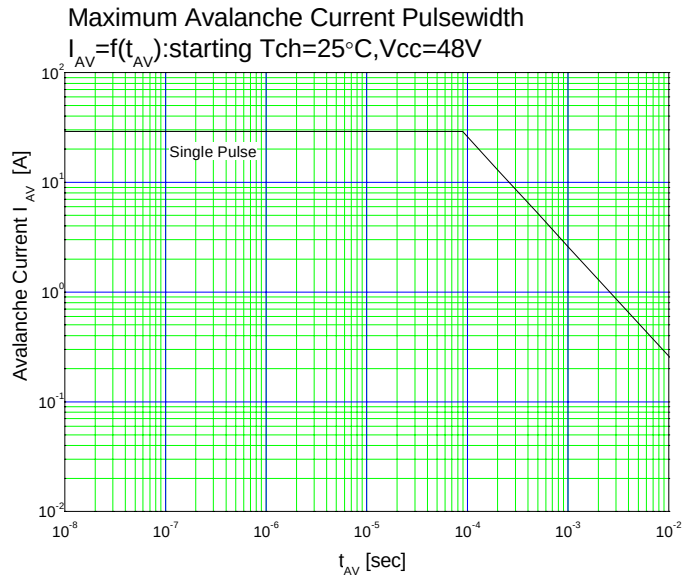
#### ■ Equivalent circuit schematic



## Characteristics

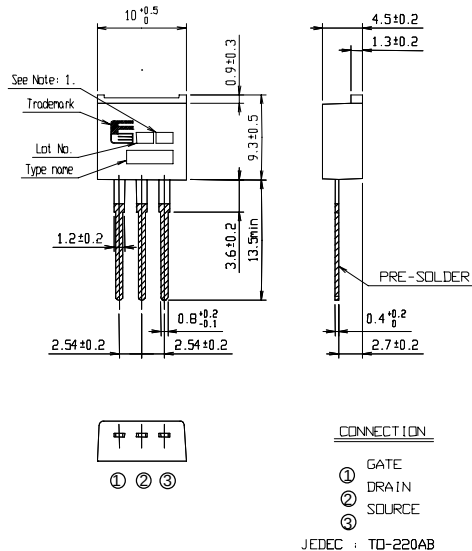




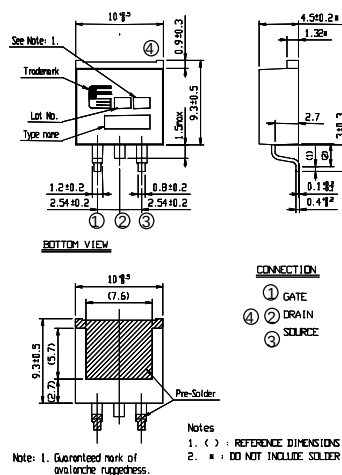


## Outline Drawings (mm)

Type(L)



Type(S)



Type(SJ)

